

Application No. 09/901,487

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Docket No.: 02598/000J593-US0

Amendment dated May 11, 2006

After Final Office Action of January 11, 2006

AMENDMENTS TO THE SPECIFICATION

Please amend the specification as follows:

[0071] As shown in FIG 13, the circuit 14 114 is bonded with the second gold bump 4 by means of ultrasonic wave and heat so as to be electrically connected to each other.

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